Search Notes



| Application/Control No. | Applicant(s)/Patent Under Reexamination |
|-------------------------|---|
| 10598514 | WANG ET AL. |
| Examiner | Art Unit |
| SELIM AHMED | 2826 |

| SEARCHED | | | | | |
|----------|----------------|------------|----------|--|--|
| Class | Subclass | Date | Examiner | | |
| 257 | 678 | 3/6/2009 | /sa/ | | |
| | Updated search | 10/12/2009 | /sa/ | | |

| SEARCH NOTES | | |
|---|------------|----------|
| Search Notes | Date | Examiner |
| EAST text search such as, package, chip/die, first/second, substrate, PCB, PWB, adhesive, die attach, stack, window/open, conductive, trace, interposer, redistribution, metal were searched. | 3/6/2009 | /sa/ |
| Updated search | 10/12/2009 | /sa/ |

| INTERFERENCE SEARCH | | | |
|---------------------|----------|------|----------|
| Class | Subclass | Date | Examiner |

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